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May 2013

# FAN2510 100 mA CMOS LDO Regulators with Fast Start Enable

#### **Features**

- · Ultra-Low Power Consumption
- · 100 mV Dropout Voltage at 100 mA
- · Output Voltage of 3.3 V
- 25 μA Ground Current at 100 mA
- · Enable / Shutdown Control
- SOT23-5 package
- · Thermal Limiting
- · 300 mA Peak Current

## **Applications**

- · Mobile Phones and Accessories
- · Portable Cameras and Video Recorders
- · Laptop, Notebook, and Palmtop Computers

## **Description**

The FAN2510 micropower low-dropout voltage regulators utilizes CMOS technology to offer a new level of cost-effective performance in mobile handsets, laptop and notebook portable computers, and other portable devices. Features include extremely low power consumption, low shutdown current, low dropout voltage, exceptional loop stability able to accommodate a wide variety of external capacitors, and a compact SOT23-5 surface-mount package.

The FAN2510 offers the fast power-cycle time required in Mobile handset applications. These products offer significant improvements over older BiCMOS designs and is pin-compatible with many popular devices. The output is thermally protected against overload.

Pin 4 allows the user to adjust the output voltage over a wide range using an external voltage divider.

## Ordering Information

Part Number	V <sub>OUT</sub>	Pin 4 Function	Top Mark	Package	Packing Method
FAN2510SX	Adj.	Adjust	ANA	SOT-23 5L	Tape and Reel

#### **Tape and Reel Information**

Quantity	Reel Size	Width
3000	7 inches	8 mm

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## **Block Diagram**

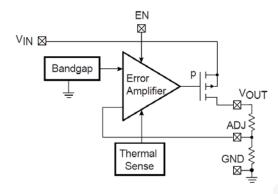


Figure 1. Block Diagram

# **Pin Configuration**

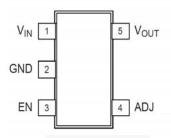


Figure 2. Pin Configuration

## **Pin Descriptions**

Pin Name	Pin No.	Туре	Functional Description	
ADJ	ADJ 4	Input	<b>FAN2510 Adjust.</b> Ratio of Potential divider from V <sub>OUT</sub> to ADJ Determines	
ADS	۲		output voltage.	
			Enable	
EN	3	Digital Input	<b>0</b> : Shutdown V <sub>OUT</sub>	
			1: Enable V <sub>OUT</sub>	
$V_{IN}$	1	Power In	Voltage Input. Supply voltage input.	
V <sub>OUT</sub>	5	Power Out	Voltage Output. Regulated output voltage.	
GND	2	Power	Ground	

### **Absolute Maximum Ratings**(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Min.	Max.	Unit		
		•		
0	7	V		
		•		
0	7	V		
Internally Limited				
-65	150	°C		
	260	°C		
-65	150	°C		
4		kV		
	0 O Inte	0 7  0 7  Internally Limited  -65 150  260  -65 150		

#### Notes:

- 1. Functional operation under any of these conditions is NOT implied. Performance and reliability are guaranteed only if Recommended Operating Conditions are not exceeded.
- 2. Applied voltage must be current limited to specified range.
- 3. Based upon thermally limited junction temperature:

$$P_D \,=\, \frac{T_{J(max)} - T_A}{\Theta_{JA}}$$

4. Human Body Model is 4 kV minimum using Mil Std. 883E, method 3015.7. Machine Model is 400 V minimum using JEDEC method A115-A.

## **Recommended Operating Conditions**

The recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Nom.	Max.	Unit
V <sub>IN</sub>	Input Voltage Range	2.7		6.5	V
V <sub>EN</sub>	Enable Input Voltage	0		V <sub>IN</sub>	V
TJ	Junction Temperature	-40		+125	°C
$\theta_{JA}$	Thermal Resistance, Junction to Air		220		°C/W
$\theta_{JC}$	Thermal Resistance, Junction to Case		130		°C/W

## Electrical Characteristics (5, 6)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Regulator						
		I <sub>OUT</sub> = 100 μA		2.5	4.0	mV
$V_{DO}$	Drop-Out Voltage	I <sub>OUT</sub> = 50 mA		50	75	mV
		I <sub>OUT</sub> = 100 mA		100	140	mV
V <sub>REF</sub>	Reference Voltage Accuracy		1.24	1.32	1.40	V
$\Delta V_{O}^{(7)}$	Output Voltage Accuracy		-6		6	%
I <sub>GND</sub>	Ground Pin Current	I <sub>OUT</sub> = 100 mA			50	μΑ
Protection						
	Current Limit		Thermally	Protecte	d	
I <sub>GSD</sub>	Shut-down Current	EN = 0 V			1	μΑ
T <sub>SH</sub>	Thermal Protection Shutdown Temperature		150			°C
Enable Inpu	ut		į.			
V <sub>IL</sub>	Logic Low Voltage			1.2	0.4	V
V <sub>IH</sub>	Logic High Voltage		2.0	1.4		V
I <sub>IH</sub>	Input Current High				1	μΑ
$I_1$	Input Current Low				1	μΑ

## **Switching Characteristics**

	Parameter	Max.	Unit
Enable Input <sup>(8)</sup>			
Response Time		500	μsec

## **Performance Characteristics**(5, 6)

Symbol	Parameter	Conditions	Тур.	Max.	Unit
$\Delta V_{OUT}/$ $\Delta V_{IN}$	Line Regulation	$V_{IN} = (V_{OUT} + 1) \text{ to } 6.5 \text{ V}$	0.3		% / V
ΔV <sub>OUT</sub> / V <sub>OUT</sub>	Load Regulation	I <sub>OUT</sub> = 0.1 to 100 mA	1.0	2.0	%
	Output Naisa	10 Hz - 1 kHz, C <sub>OUT</sub> = 10 μF, C <sub>BYP</sub> = 0.01 μF	< 7.00		\ \( \sigma \)
e <sub>N</sub>	Output Noise	$f > 10 \text{ kHz},$ $C_{OUT} = 10 \mu\text{F},$ $C_{BYP} = 0.01 \mu\text{F}$	< 0.01		µV ∬Hz
PSRR	Power Supply Rejection	f = 120 Hz at V <sub>IN</sub> , $C_{OUT}$ = 10 $\mu$ F, $C_{BYP}$ = 0.01 $\mu$ F	43		dB

#### Notes:

- 5. Unless otherwise stated; T<sub>A</sub> = 25°C, V<sub>IN</sub> = V<sub>OUT</sub> + 1 V, I<sub>OUT</sub> = 100  $\mu$ A, and V<sub>IH</sub> > 2.0 V.
- 6. Bold values indicate -40 ≤ T<sub>J</sub> ≤ 125°C.
- 7. The adjustable version has a band-gap voltage range of 1.24 V to 1.40 V with a nominal value of 1.32 V.
- 8. When using repeated cycling.

## **Typical Performance Characteristics**

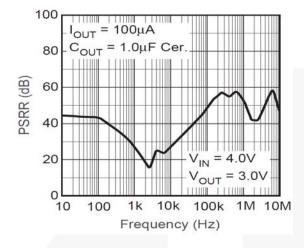


Figure 3. Power Supply Rejection Ratio

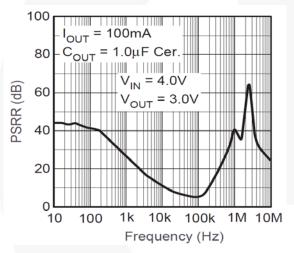


Figure 5. Power Supply Rejection Ratio

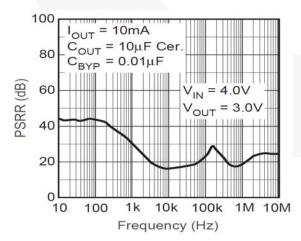


Figure 7. Power Supply Rejection Ratio

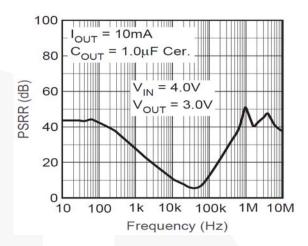


Figure 4. Power Supply Rejection Ratio

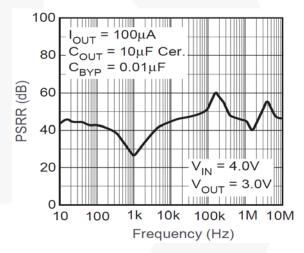


Figure 6. Power Supply Rejection Ratio

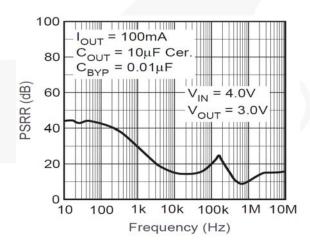


Figure 8. Power Supply Rejection Ratio

Downloaded from **Arrow.com**.

#### **Typical Performance Characteristics** (Countinued) 70 70 60 60 $= 100 \mu A$ = 10mAOUT 50 50 PSRR (dB) PSRR (dB) 10mA 40 40 30 100μΑ 30 $C_{OUT} = 1.0 \mu F Cer.$ 100mA 20 20 $C_{OUT} = 10\mu F Cer$ 100mA 10 10 0 3.0 3.6 4.1 3.0 4.1 Voltage (V) Voltage (V) Figure 9. Power Supply Rejection Ratio vs. Voltage Figure 10. Power Supply Rejection Ratio vs. Voltage Drop 10 30.00 $V_{IN} = 4V$ 1 28.00 Quiescent Current (µA) $V_{OUT} = 3V$ Noise (μV//Hz) 0.1 26.00 0.01 24.00 $= 1.0 \mu F$ 22.00 0.001 $= 0.01 \mu F$ 10µA 20.00 0.0001 10 0.1 100 10 100 10k 100k Load Current (mA) Frequency (Hz) Figure 11. Noise Performance Figure 12. Ground Pin Current 35.00 35.00 30.00 30.00 Quiescent Current (µA) Quiescent Current (µA) 25.00 25.00 20.00 20.00 15.00 15.00 10.00 10.00 $V_{OUT} = 3V$ $V_{OUT} = 3V$ 5.00 I<sub>OUT</sub> = 100mA 5.00 $I_{OUT} = 100 \mu A$ 0.00 0.00 6.0 3.0 5.0 7.0 4.0 5.0 7.0 3.0 6.0 Input Voltage (V) Input Voltage (V) Figure 13. Ground Pin Current Figure 14. Ground Pin Current

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## **Typical Performance Characteristics** (Countinued)

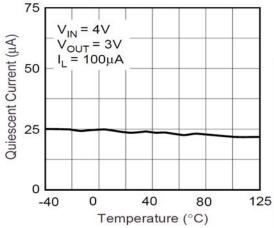


Figure 15. Ground Pin Current Figure 16. Ground Pin Current

75

50

25

0

-40

Quiescent Current (µA)

**V**<sub>IN</sub> = 4**V** 

 $V_{OUT} = 3V$   $I_L = 100 \text{mA}$ 

0

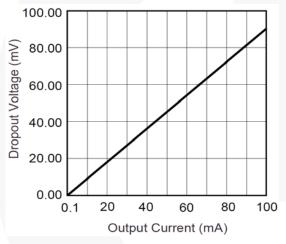


Figure 17. Dropout Voltage

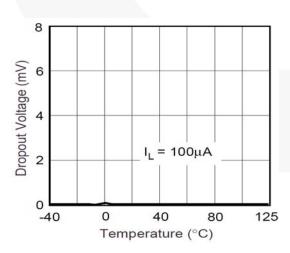
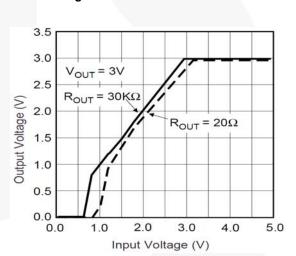


Figure 19. Dropout Voltage



40

Temperature (°C)

80

Figure 18. Dropout Characteristics

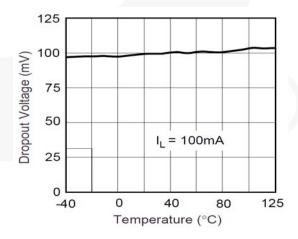


Figure 20. Dropout Voltage

## **Typical Performance Characteristics** (Countinued)

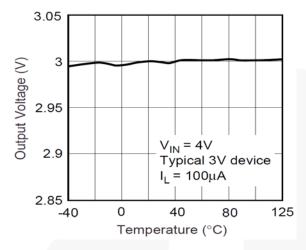


Figure 21. Output Voltage vs. Temperature

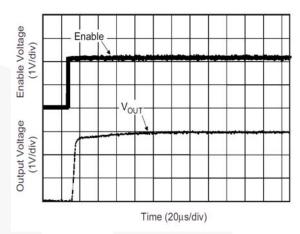


Figure 22. Enable Pin Delay

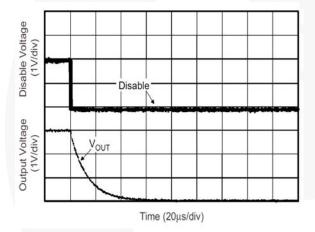


Figure 23. Shutdown Delay

#### **Functional Description**

Designed utilizing CMOS process technology, the FAN2510 is carefully optimized for use in compact battery-powered devices. It offers a unique combination of low power consumption, extremely low dropout voltages, high tolerance for a variety of output capacitors, and the ability to disable the output to less than 1 µA under user control. In the circuit, a difference amplifier controls the current through a series-pass P-channel MOSFET, comparing the load voltage at the output with an onboard low-drift band-gap reference. The series resistance of the pass P-channel MOSFET is approximately 1  $\Omega$ . resulting in an unusually low dropout voltage under load when compared to older bipolar pass-transistor designs. Protection circuitry is provided onboard for overload conditions. If the device reaches temperatures exceeding the specified maximums, an onboard circuit shuts down the output, where it remains suspended until it has cooled before re-enabling. The user can shut down the device using the enable control pin at any time.

Careful design of the output regulator amplifier assures loop stability over a wide range of ESR values in the external output capacitor. A wide range of values and types can be accomodated, allowing the user to select a capacitor meeting if space, cost, and performance requirements, while enjoying reliable operation over temperature, load, and tolerance variations.

An enable pin allows the user to shut down the regulator output to conserve power, reducing supply current to less than 1  $\mu$ A. The output can then be re-Enabled within 500  $\mu$ s, fulfilling the fast power-cycling needs of Mobile applications. The adjustable voltage version utilize pin 4 to connect to an external voltage divider which feeds back to the regulator error amplifier, thereby setting the voltage as desired.

#### **Applications Information**

#### External Capacitors – Selection

The FAN2510 supports a wide variety of capacitors compared to other LDO products. An innovative design approach offers significantly reduced sensitivity to ESR (Equivalent Series Resistance), which degrades regulator loop stability in older designs. While the improvements greatly simplifies the design task, capacitor quality still must be considered if the designer is to achieve optimal circuit performance. In general, ceramic capacitors offer superior ESR performance, at a lower cost and a smaller case size than tantalums. Those with X7R or Y5V dielectric offer the best temperature coefficient characteristics. The combination of tolerance and variation over temperature in some capacitor types can result in significant variations, resulting in unstable performance over rated conditions.

#### **Input Capacitor**

An input capacitor of 2.2  $\mu F$  (nominal value) or greater, connected between the input pin and ground, located in close proximity to the device, improves transient response and noise rejection. Higher values offer superior input ripple rejection and transient response. An input capacitor is recommended when the input source, either a battery or a regulated AC voltage, is located far from the device. Any good-quality ceramic, tantalum, or metal film capacitor gives acceptable performance; however, tantalum capacitors with a surge current rating appropriate to the application must be selected to avoid catastrophic failure.

#### **Output Capacitor**

An output capacitor is required to maintain regulator loop stability. Unlike many other LDO regulators, the FAN2510 is nearly insensitve to output capacitor ESR. Stable operation is achieved with a wide variety of capacitors with ESR values ranging from 10 m $\Omega$  to 10  $\Omega$  or more. Tantalum or aluminum electrolytic, or multilayer ceramic types can be used. A nominal value of at least 1 uF is recommended.

#### **Control Functions**

#### **Enable Pin**

Applying a voltage of 0.4 V or less at the Enable pin disables the output, reducing the quiescent output current to less than 1  $\mu$ A; while a voltage of 2.0 V or greater enables the device. If this shutdown function is not needed, the pin can be connected to the V<sub>IN</sub> pin. Allowing this pin to float causes erratic operation.

#### **Thermal Protection**

The FAN2510 supply high peak output currents of up to 1 A for brief periods; however, this output load causes the device temperature to increase and exceed maximum ratings due to power dissipation. During output overload conditions, when the die temperature exceeds the shutdown limit temperature of 150°C, onboard thermal protection disables the output until the temperature drops below this limit; at which point, the output is reenabled. During a thermal shutdown situation, the user may assert the power-down function at the enable pin, reducing power consumption to the minimum level  $I_{\mbox{\footnotesize GND}} \cdot V_{\mbox{\footnotesize IN}}.$ 

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#### **Thermal Characteristics**

The FAN2510 can supply 100 mA at the specified output voltage with an operating die (junction) temperature of up to 125°C. Once the power dissipation and thermal resistance is known, the maximum junction temperature of the device can be calculated. While the power dissipation is calculated from known electrical parameters, the thermal resistance is a result of the thermal characteristics of the compact SOT23-5 surface-mount package and the surrounding PC Board copper to which it is mounted.

The power dissipation is equal to the product of the input-tooutput voltage differential and the output current plus the ground current multiplied by the input voltage, or:

$$P_{D} = (V_{IN} - V_{OUT})I_{OUT} + V_{IN}I_{GND}$$

The ground pin current, I<sub>GND</sub>, can be found in the charts provided in the Electrical Characteristics section.

The relationship describing the thermal behavior of the package is:

$$P_{D(max)} = \left\{ \frac{T_{J(max)} - T_{A}}{\theta_{JA}} \right\}$$

where T<sub>J(max)</sub> is the maximum allowable junction temperature of the die, which is 125°C, and TA is the ambient operating temperature.  $\theta_{JA}$  is dependent on the surrounding PC board layout and can be empirically obtained. While the  $\theta_{JC}$  (junction-to-case) of the SOT23-5 package is specified at 130°C/W, the θ<sub>JA</sub> of the minimum PCB footprint is at least 235°C/W. This can be improved by providing a heat sink of surrounding copper ground on the PCB. Depending on the size of the copper area, the resulting  $\theta_{JA}$  can range from approximately 180°C/W for one square inch to nearly 130°C/W for four square inches. The addition of backside copper with through-holes, stiffeners, and other enhancements can reduce this value. The heat contributed by the dissipation of other devices located nearby must be included in design considerations.

Once the limiting parameters in these two relationships have been determined, the design can be modified to ensure that the device remains within specified operating conditions. If overload conditions are not considered, it is possible for the device to enter a thermal cycling loop, in which the circuit enters a shutdown condition, cools, reenables, and then again overheats and shuts down repeatedly due to an unmanaged fault condition.

#### **Operational of Adjustable Version**

The adjustable version of the FAN2500 includes an input pin ADJ which allows the user to select an output voltage ranging from 1.8 V to near  $V_{\text{IN}}$ , using an external resistor divider. The voltage  $V_{\text{ADJ}}$  presented to the ADJ pin is fed to the onboard error amplifier which adjusts the output voltage until  $V_{\text{ADJ}}$  is equal to the onboard band-gap reference voltage of 1.32 V (typ). The equation is:

$$V_{OUT} = 1.32V \times \left[1 + \frac{R_{upper}}{R_{lower}}\right]$$

The total value of the resistor chain should not exceed 250  $k\Omega$  total to keep the error amplifier biased during noload conditions. Programming output voltages near  $V_{IN}$  need to allow for the magnitude and variation of the dropout voltage  $V_{DO}$  over load, supply, and temperature

variations. Note that the low-leakage FET input to the CMOS Error Amplifier induces no bias current error to the calculation.

#### **General PCB Layout Considerations**

To achieve the full performance of the device, careful circuit layout and grounding technique must be observed. Establishing a small local ground, to which the GND pin and the output and bypass capacitors are connected, is recommended The input capacitor should be grounded to the main ground plane. The quiet local ground is routed back to the main ground plane using feed-through vias. In general, the high-frequency compensation components (input, bypass, and output capacitors) should be located as close to the device as possible. The proximity of the output capacitor is especially important to achieve optimal noise compensation from the onboard error amplifier, especially during high load conditions. A large copper area in the local ground provides the heat sinking discussed above when high power dissipation significantly increases the temperature of the device. Component-side copper provides significantly better thermal performance for this surface-mount device, compared to that obtained when using only copper planes on the underside.



## **Physical Dimensions**

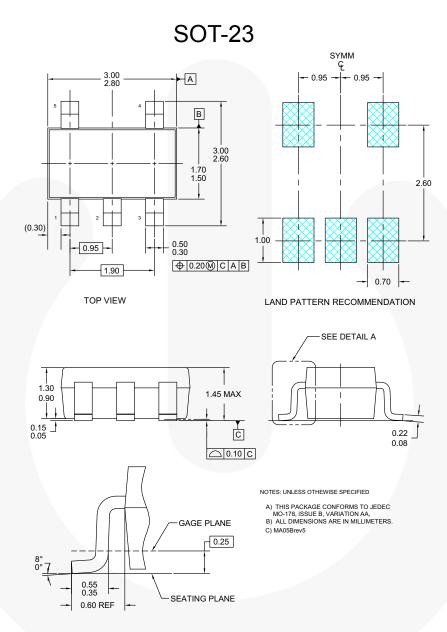


Figure 24. 5-LEAD, SOT-23, JEDEC MO-178, 1.6 mm

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